

## FEATURES

- ◆ Ultra Low Supply Current: 1.9µA at 25kHz
- ◆ Supply Voltage Operation: 1.55V to 5.25V
- ◆ Single Resistor Sets FOUT at 50% Duty Cycle
- ◆ FOUT Period:
  - 9kHz ≤ FOUT ≤ 300kHz
- ◆ Single Resistor Sets Output Frequency
- ◆ FOUT Period Accuracy: 3%
- ◆ FOUT Period Drift: 0.02%/°C
- ◆ FOUT Output Driver Resistance: 160Ω

## APPLICATIONS

- Portable and Battery-Powered Equipment
- Low-Parts-Count Nanopower Oscillator
- Compact Micropower Replacement for Crystal and Ceramic Oscillators
- Micropower Pulse-width Modulation Control
- Micropower Pulse-position Modulation Control
- Micropower Clock Generation
- Micropower Sequential Timing

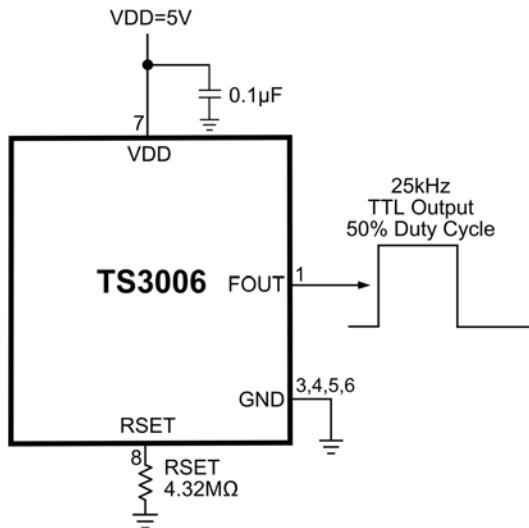
## DESCRIPTION

The TS3006 is a single-supply, second-generation oscillator/timer fully specified to operate at a supply voltage range of 1.55V to 5.25V while consuming less than 2.4µA(max) supply current. Requiring only a resistor to set the base output frequency (or output period) at 25kHz (or 40µs) with a 50% duty cycle, the TS3006 timer/oscillator is compact, easy-to-use, and versatile. Optimized for ultra-long life, low frequency, battery-powered/portable applications, the TS3006 joins the TS3001, TS3002, TS3004, and TS3005 in the CMOS timer family of "NanoWatt Analog™" high-performance analog integrated circuits.

The TS3006 output frequency can be user-adjusted from 9kHz to 300kHz with a single resistor. In addition, the TS3006 represents a 25% reduction in pcb area and a factor-of-10 lower power consumption over other CMOS-based integrated circuit oscillators/timers. When compared against industry-standard 555-timer-based products, the TS3006 offers up to 84% reduction in pcb area and over three orders of magnitude lower power consumption.

The TS3006 is fully specified over the -40°C to +85°C temperature range and is available in a low-profile, 8-pin 3x3mm TDFN package with an exposed back-side paddle.

## TYPICAL APPLICATION CIRCUIT



# TS3006

## ABSOLUTE MAXIMUM RATINGS

V <sub>DD</sub> to GND.....	-0.3V to +5.5V
PWM_CNTRL to GND.....	-0.3V to +5.5V
FOUT, PWMOUT to GND.....	-0.3V to +5.5V
RSET to GND.....	-0.3V to +2.5V
CPWM to GND.....	-0.3V to +5.5V
FDIV to GND.....	-0.3V to +5.5V

Continuous Power Dissipation (T <sub>A</sub> = +70°C)	
8-Pin TDFN (Derate at 23.8mW/°C above +70°C).....	1951mW
Operating Temperature Range.....	-40°C to +85°C
Storage Temperature Range.....	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+300°C

Electrical and thermal stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to any absolute maximum rating conditions for extended periods may affect device reliability and lifetime.

## PACKAGE/ORDERING INFORMATION

TOP VIEW			
FOUT	1	8	RSET
TS3006			
NC	2	7	VDD
GND	3	6	GND
GND	4	5	GND
3mm x 3mm x 0.75mm DFN-EP 8L TD833 Package			
ORDER NUMBER	PART MARKING	CARRIER	QUANTITY
TS3006ITD833	3006I	Tape & Reel	-----
TS3006ITD833T		Tape & Reel	3000

**Lead-free Program:** Silicon Labs supplies only lead-free packaging.

Consult Silicon Labs for products specified with wider operating temperature ranges.

## ELECTRICAL CHARACTERISTICS

$V_{DD} = 3V$ ,  $V_{PWM\_CNTRL} = V_{DD}$ ,  $R_{SET} = 4.32M\Omega$ ,  $R_{LOAD(FOUT)} = \text{Open Circuit}$ ,  $C_{LOAD(FOUT)} = 0pF$  unless otherwise noted. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted. See Note 1.

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	$V_{DD}$		1.55		5.25	V
Supply Current	$I_{DD}$			1.9	2.4	$\mu\text{A}$
			$-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$		2.7	
FOUT Period	$t_{FOUT}$		39	40.1	41.2	$\mu\text{s}$
			$-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$	38	42	
FOUT Period Line Regulation	$\Delta t_{FOUT}/V$	$1.55V \leq V_{DD} \leq 5.25V$		0.17		%/V
FOUT Duty cycle			49		51	%
FOUT Period Temperature Coefficient	$\Delta t_{FOUT}/\Delta T$			0.02		%/ $^\circ\text{C}$
UVLO Hysteresis	$V_{UVLO}$	$(V_{DD}=1.55V) - (V_{DD\_SHUTDOWN VOLTAGE})$	150		250	mV
FOUT Rise Time	$t_{RISE}$	See Note 2, $C_L = 15\text{pF}$		10		ns
FOUT Fall Time	$t_{FALL}$	See Note 2, $C_L = 15\text{pF}$		10		ns
FOUT Jitter		See Note 3		0.001		%
RSET Pin Voltage	$V(RSET)$			0.3		V
Maximum Oscillator Frequency	$F_{osc}$	$RSET = 360\text{K}$			300	kHz
High Level Output Voltage, FOUT	$V_{DD} - V_{OH}$	$I_{OH} = 1\text{mA}$		160		mV
Low Level Output Voltage, FOUT	$V_{OL}$	$I_{OL} = 1\text{mA}$		140		mV

**Note 1:** All devices are 100% production tested at  $T_A = +25^\circ\text{C}$  and are guaranteed by characterization for  $T_A = T_{MIN}$  to  $T_{MAX}$ , as specified.

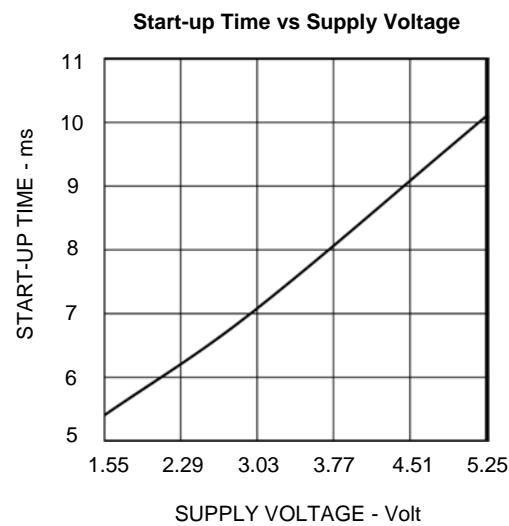
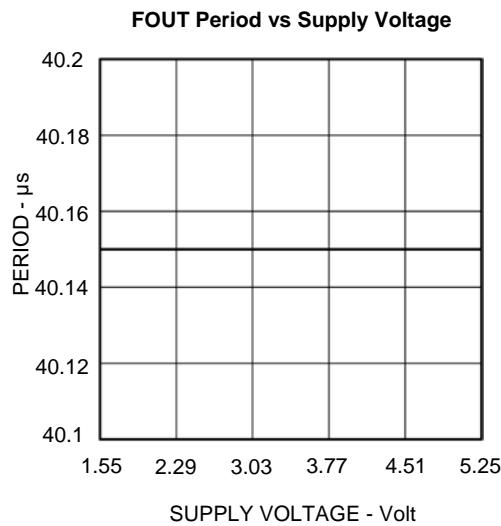
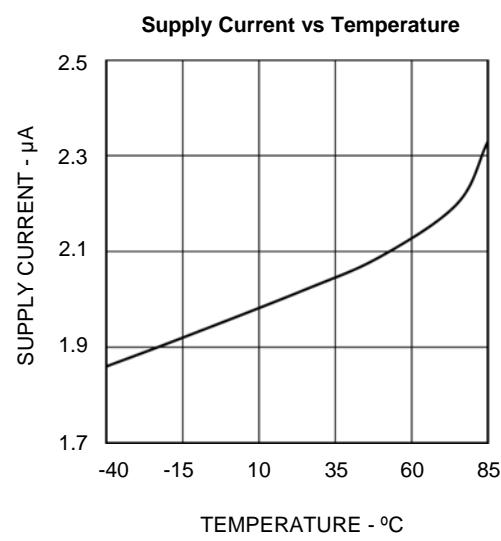
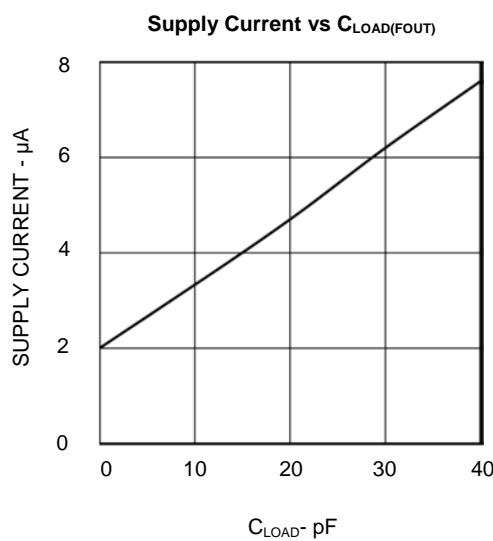
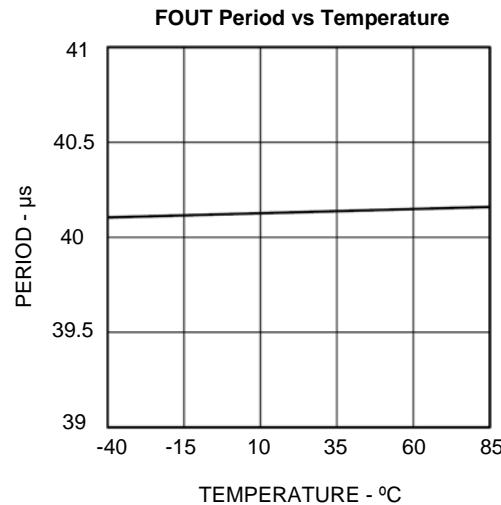
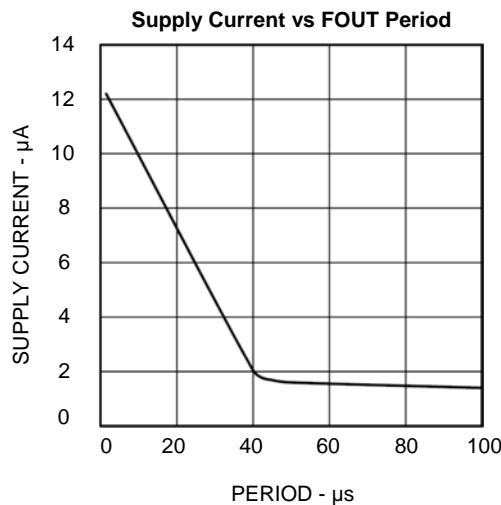
**Note 2:** Output rise and fall times are measured between the 10% and 90% of the  $V_{DD}$  power-supply voltage levels. The specification is based on lab bench characterization and is not tested in production.

**Note 3:** Timing jitter is the ratio of the peak-to-peak variation of the period to the mean of the period. The specification is based on lab bench characterization and is not tested in production.

# TS3006

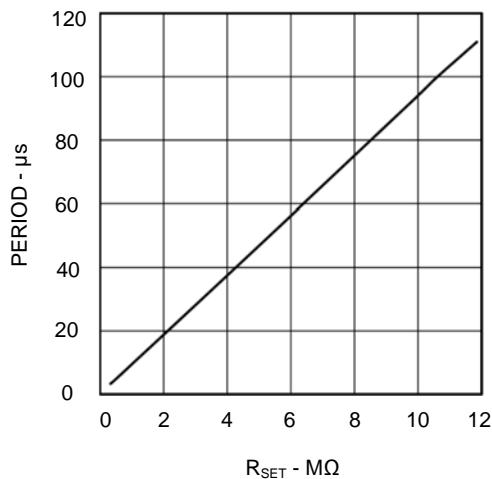
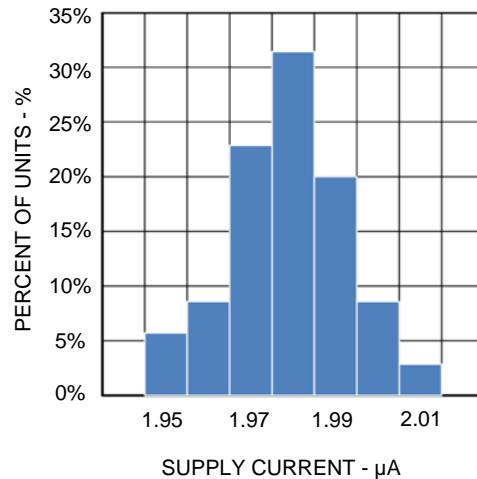
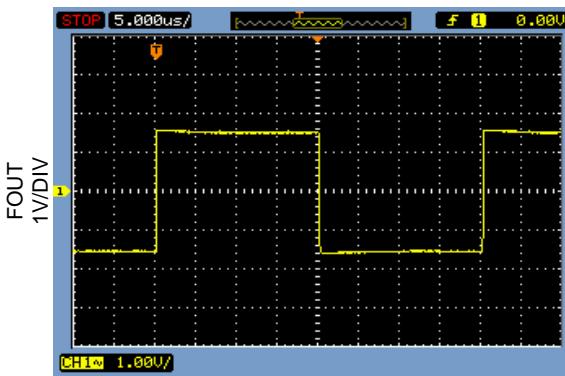
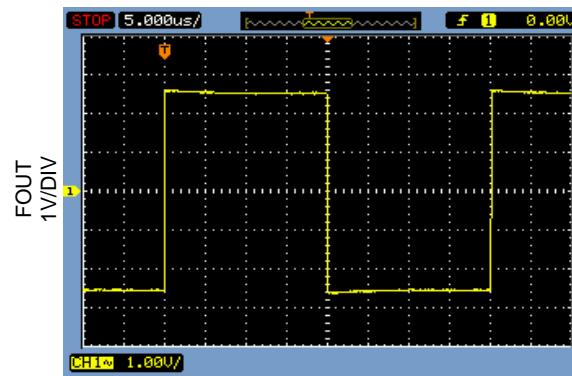
## TYPICAL PERFORMANCE CHARACTERISTICS

$V_{DD} = 3V$ ,  $V_{PWM\_CNTRL} = V_{DD}$ ,  $R_{SET} = 4.32M\Omega$ ,  $R_{LOAD(FOUT)} = \text{Open Circuit}$ ,  $C_{LOAD(FOUT)} = 0pF$  unless otherwise noted. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.



**TYPICAL PERFORMANCE CHARACTERISTICS**

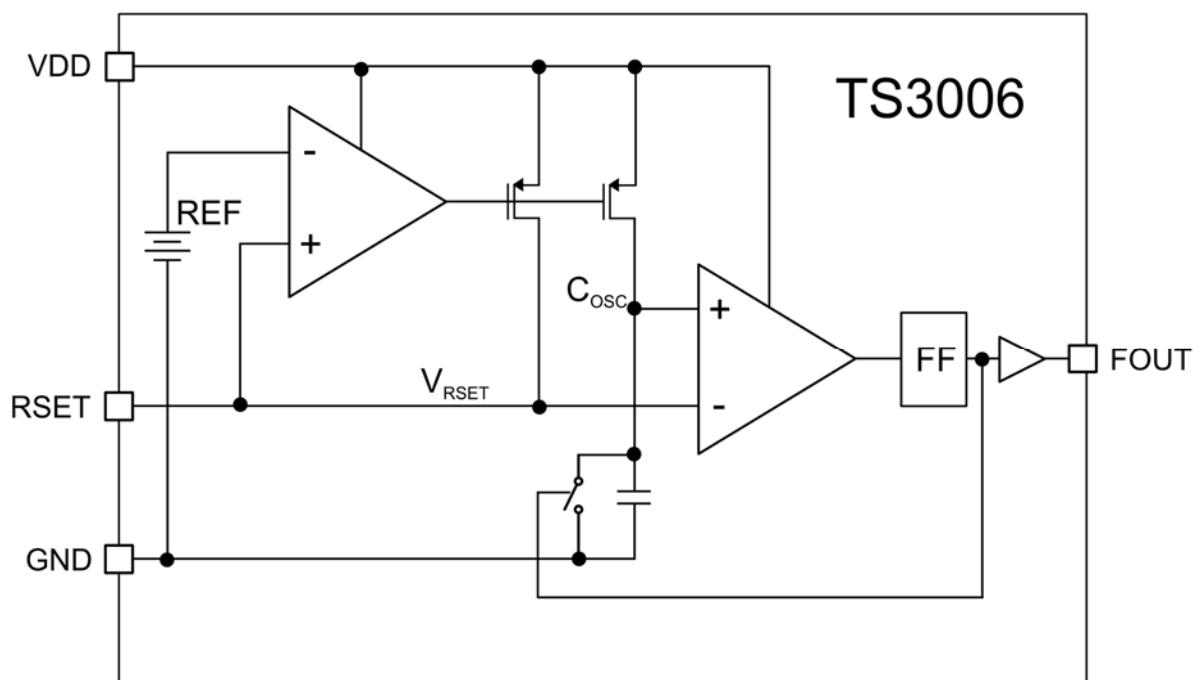
$V_{DD} = 3V$ ,  $V_{PWM\_CTRL} = V_{DD}$ ,  $R_{SET} = 4.32M\Omega$ ,  $R_{LOAD(FOUT)} = \text{Open Circuit}$ ,  $C_{LOAD(FOUT)} = 0pF$  unless otherwise noted. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

**Period vs  $R_{SET}$** 

**Supply Current Distribution**

**F<sub>OUT</sub>**  
 $V_{DD} = 3V$ ,  $C_{LOAD} = 15pF$ 

5 $\mu\text{s/DIV}$ 
**F<sub>OUT</sub>**  
 $V_{DD} = 5V$ ,  $C_{LOAD} = 15pF$ 

5 $\mu\text{s/DIV}$

## PIN FUNCTIONS

PIN	NAME	FUNCTION
1	FOUT	Fixed Frequency Output. A push-pull output stage with an output resistance of $160\Omega$ . FOUT pin swings from GND to VDD. For lowest power operation, capacitance loads should be minimized and resistive loads should be maximized.
2	NC	Non-Connect.
3,4,5,6	GND	Ground. Connect this pin to the system's analog ground plane.
7	VDD	Power Supply Voltage Input. The supply voltage range is $1.55V \leq V_{DD} \leq 5.25V$ . Bypass this pin with a $0.1\mu F$ ceramic coupling capacitor in close proximity to the TS3006.
8	RSET	FOUT Programming Resistor Input. A $4.32M\Omega$ resistor connected from this pin to ground sets the T3003's internal oscillator's output period to $40\mu s$ (25KHz). For optimal performance, the composition of the RSET resistor shall be consistent with a tolerance of 1% or lower. The RSET pin voltage is approximately 0.3V.

## BLOCK DIAGRAM



## THEORY OF OPERATION

The TS3006 is a user-programmable oscillator where the period of the square wave at its FOUT terminal is generated by an external resistor connected to the RSET pin. The output frequency is given by:

$$F_{OUT} (\text{kHz}) = \frac{1.08E11}{R_{SET}}$$

**Equation 1.** FOUT Frequency Calculation

With an  $R_{SET} = 4.32\text{M}\Omega$ , the output frequency is approximately 25kHz with a 50% duty cycle. As design aids, Tables 1 lists TS3006's typical FOUT for various standard values for  $R_{SET}$ .

<b>R<sub>SET</sub> (MΩ)</b>	<b>F<sub>OUT</sub> (kHz)</b>
0.360	300
1	108
2.49	43.37
4.32	25
6.81	15.86
9.76	11.07
12	9

**Table 1:** FOUT vs R<sub>SET</sub>

Connect CPWM to VDD to disable the PWM function and in turn, save power. Connect PWM\_CNTRL to VDD for a fixed PWMOUT output pulse width, which is determined by the CPWM pin capacitor only.

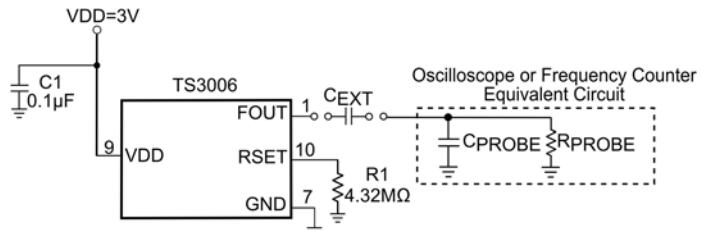
## APPLICATIONS INFORMATION

### Minimizing Power Consumption

To keep the TS3006's power consumption low, resistive loads at the FOUT and PWMOUT terminals increase dc power consumption and therefore should be as large as possible. Capacitive loads at the FOUT and PWMOUT terminals increase the TS3006's transient power consumption and, as well, should be as small as possible.

One challenge to minimizing the TS3006's transient power consumption is the probe capacitance of oscilloscopes and frequency counter instruments. Most instruments exhibit an input capacitance of 15pF or more. Unless buffered, the increase in transient load current can be as much as 400nA.

To minimize capacitive loading, the technique shown in Figure 1 can be used. In this circuit, the principle of series-connected capacitors can be used to reduce the effective capacitive load at the TS3006's FOUT and PWMOUT terminals.



**Figure 1:** Using an External Capacitor in Series with Probes Reduces Effective Capacitive Load.

To determine the optimal value for  $C_{EXT}$  once the probe capacitance is known by simply solving for  $C_{EXT}$  using the following expression:

$$C_{EXT} = \frac{1}{\frac{1}{C_{LOAD(EFF)}} - \frac{1}{C_{PROBE}}}$$

**Equation 2:** External Capacitor Calculation

For example, if the instrument's input probe capacitance is 15pF and the desired effective load capacitance at either or both FOUT and PWMOUT terminals is to be  $\leq 5\text{pF}$ , then the value of  $C_{EXT}$  should be  $\leq 7.5\text{pF}$ .

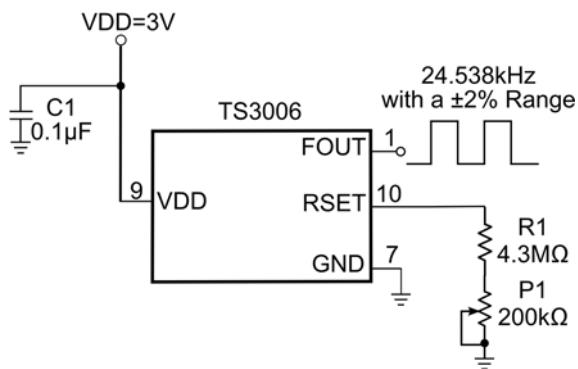
### TS3006 Start-up Time

As the TS3006 is powered up, its FOUT terminal (and PWMOUT terminal, if enabled) is active once the applied VDD is higher than 1.55V. Once the applied VDD is higher than 1.55V, the master oscillator achieves steady-state operation within 8ms.

# TS3006

## Using a Potentiometer to Trim the TS3006's Output Frequency

By using a fixed resistor and a potentiometer, the output frequency of the TS3006 can be trimmed as shown in Figure 2. By selecting a fixed resistor R1 with a tolerance of 0.1% and a potentiometer P1 with a 5% tolerance, the output frequency can be trimmed to provide a  $\pm 2\%$  trimming range

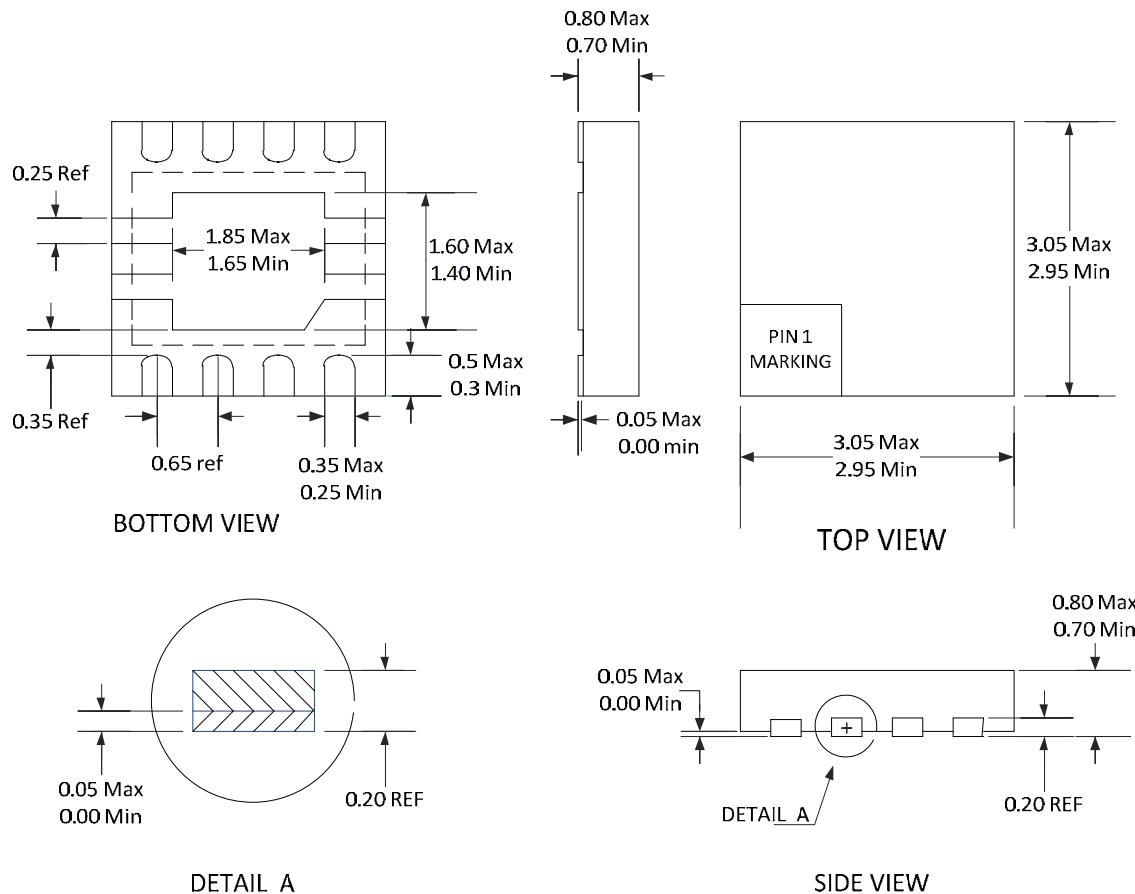


**Figure 2:** Using a Fixed Resistor and a Potentiometer to Trim the TS3006's Output Frequency.

## PACKAGE OUTLINE DRAWING

### 8-Pin TDFN33 Package Outline Drawing

(N.B., Drawings are not to scale)



NOTE: CONTROLLING DIMENSIONS IN MILLIMETERS  
 Compliant with JEDEC MO-229

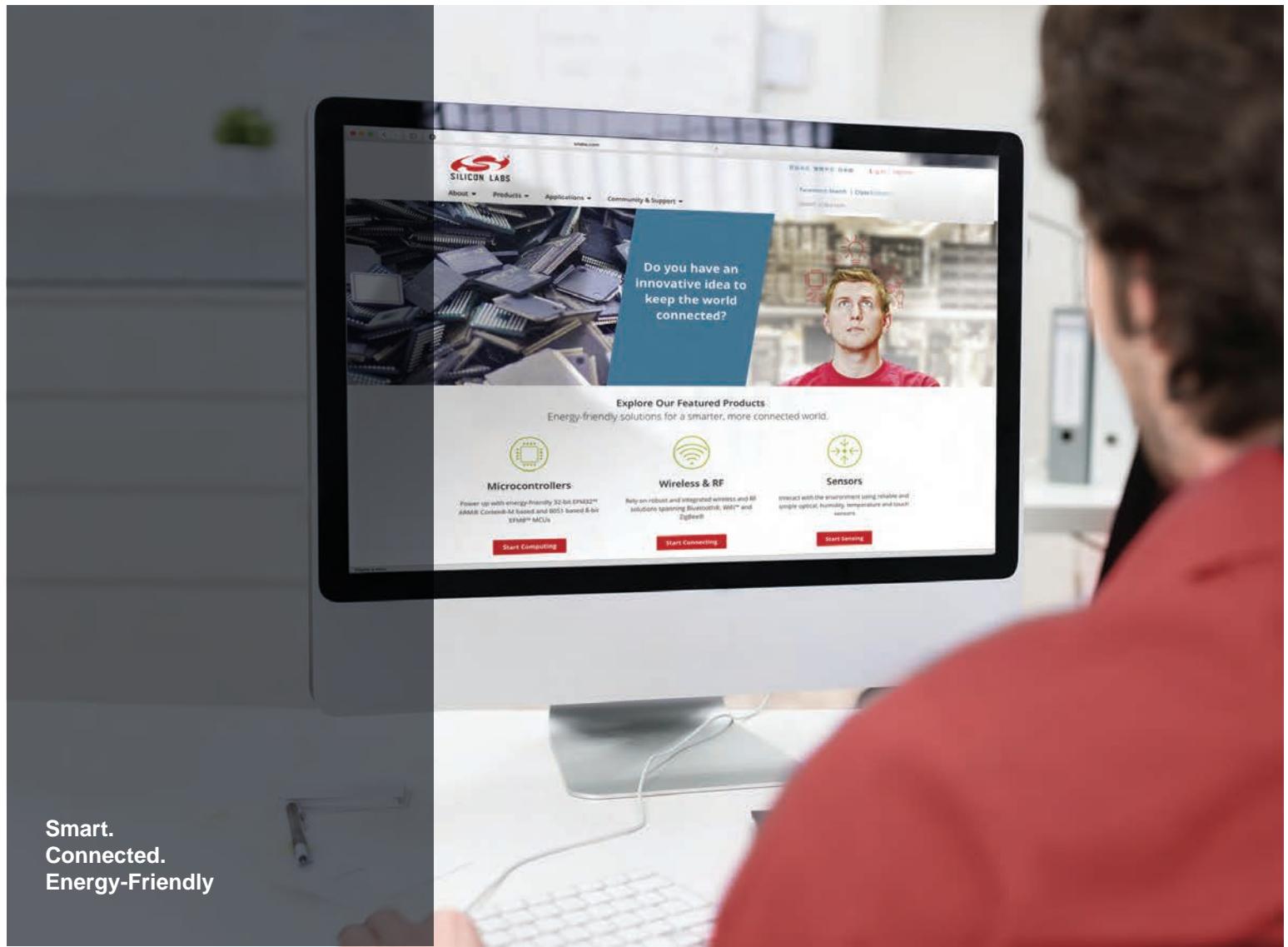
#### Patent Notice

Silicon Labs invests in research and development to help our customers differentiate in the market with innovative low-power, small size, analog-intensive mixed-signal solutions. Silicon Labs' extensive patent portfolio is a testament to our unique approach and world-class engineering team.

The information in this document is believed to be accurate in all respects at the time of publication but is subject to change without notice. Silicon Laboratories assumes no responsibility for errors and omissions, and disclaims responsibility for any consequences resulting from the use of information included herein. Additionally, Silicon Laboratories assumes no responsibility for the functioning of undescribed features or parameters. Silicon Laboratories reserves the right to make changes without further notice. Silicon Laboratories makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Silicon Laboratories assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. Silicon Laboratories products are not designed, intended, or authorized for use in applications intended to support or sustain life, or for any other application in which the failure of the Silicon Laboratories product could create a situation where personal injury or death may occur. Should Buyer purchase or use Silicon Laboratories products for any such unintended or unauthorized application, Buyer shall indemnify and hold Silicon Laboratories harmless against all claims and damages.

Silicon Laboratories and Silicon Labs are trademarks of Silicon Laboratories Inc.

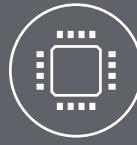
Other products or brandnames mentioned herein are trademarks or registered trademarks of their respective holders.



Smart.  
Connected.  
Energy-Friendly



**Products**  
[www.silabs.com/products](http://www.silabs.com/products)



**Quality**  
[www.silabs.com/quality](http://www.silabs.com/quality)



**Support and Community**  
[community.silabs.com](http://community.silabs.com)

#### Disclaimer

Silicon Laboratories intends to provide customers with the latest, accurate, and in-depth documentation of all peripherals and modules available for system and software implementers using or intending to use the Silicon Laboratories products. Characterization data, available modules and peripherals, memory sizes and memory addresses refer to each specific device, and "Typical" parameters provided can and do vary in different applications. Application examples described herein are for illustrative purposes only. Silicon Laboratories reserves the right to make changes without further notice and limitation to product information, specifications, and descriptions herein, and does not give warranties as to the accuracy or completeness of the included information. Silicon Laboratories shall have no liability for the consequences of use of the information supplied herein. This document does not imply or express copyright licenses granted hereunder to design or fabricate any integrated circuits. The products must not be used within any Life Support System without the specific written consent of Silicon Laboratories. A "Life Support System" is any product or system intended to support or sustain life and/or health, which, if it fails, can be reasonably expected to result in significant personal injury or death. Silicon Laboratories products are generally not intended for military applications. Silicon Laboratories products shall under no circumstances be used in weapons of mass destruction including (but not limited to) nuclear, biological or chemical weapons, or missiles capable of delivering such weapons.

#### Trademark Information

Silicon Laboratories Inc., Silicon Laboratories, Silicon Labs, SiLabs and the Silicon Labs logo, CMEMS®, EFM, EFM32, EFR, Energy Micro, Energy Micro logo and combinations thereof, "the world's most energy friendly microcontrollers", Ember®, EZLink®, EZMac®, EZRadio®, EZRadioPRO®, DSPLL®, ISOmodem®, Precision32®, ProSLIC®, SiPHY®, USBXpress® and others are trademarks or registered trademarks of Silicon Laboratories Inc. ARM, CORTEX, Cortex-M3 and THUMB are trademarks or registered trademarks of ARM Holdings. Keil is a registered trademark of ARM Limited. All other products or brand names mentioned herein are trademarks of their respective holders.



**Silicon Laboratories Inc.**  
400 West Cesar Chavez  
Austin, TX 78701  
USA

<http://www.silabs.com>